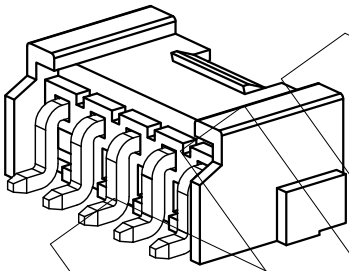


零件图	成品图	客户图
		○

REVISION DATA				
REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	Zhang	2017-08-28

Pin	A	B	C
2	3.96	11.88	8.6
3	7.92	15.84	12.56
4	11.88	19.8	16.52
5	15.84	23.76	20.48
6	19.8	27.72	24.44
7	23.76	31.68	28.4
8	27.72	35.64	32.36
9	31.68	39.6	36.32
10	35.64	43.56	40.28

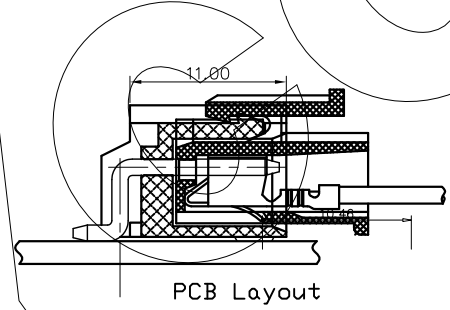
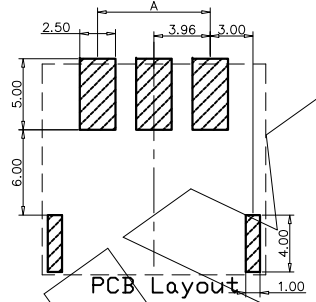
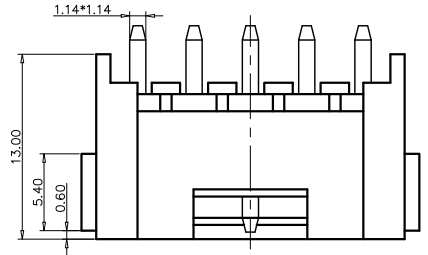
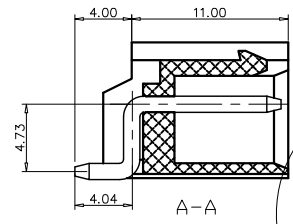
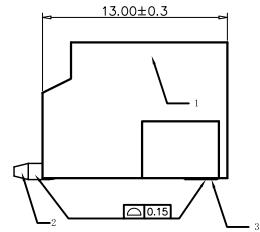
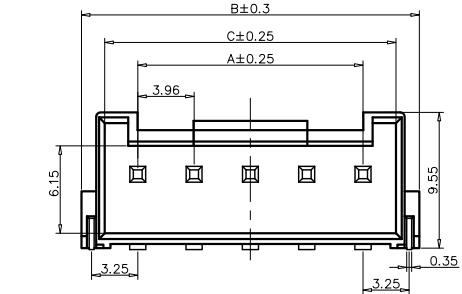


Technical Data

Material:
 Contact Material: Copper Alloy
 Contact plating: Au or Sn Over Ni
 Insulator Material: See the table, UL94 V-0

Electrical:
 Rating current: 7Amps/contact max.
 Rating voltage : 250 V AC/DC
 Contact resistance: $\leq 20m\Omega$ /contact
 Insulation resistance: $\geq 1000M\Omega$
 Withstanding Voltage: 1500V AC/minute

Mechanical:
 Operating temperatures: Gold Plated: $-55^{\circ}C$ to $+105^{\circ}C$
 Tin plated: $-40^{\circ}C$ to $+105^{\circ}C$
 Soldering temperature: $+260^{\circ}C$, max(PA66)
 $+220^{\circ}C$, max(PBT)



MATERIALS & PLATINGS TABLE

WF	D	H	11	XXX	XX	X	N	H001
Pitch(mm) A 2.5 B 2.0 C 1.25 D 3.96 E 2.54 F 3.0 G 1.0 P 3.25	Angel Options R 90° D 180° S SMT H 卧式SMT	Product Type 11 Single row	No. of Positions XXX Poles	Pin Plating G0 Gold Flash SN TiN	Insulator Material A PBT B PA66 C PA6T D LCP E PA46 F PA9T	N NO Peg	Series NO.	

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DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD

TOLERANCE	DATE :	2017-08-28	TITLE:	PH3.96 H9.55 WAFER SMT WAFER
ANGLE $\pm 5^{\circ}$	DRAWN :	Zhang	PART NO: WFDH11XXXXXXNH001	REV: A0 UNIT: mm SCALE: 1:1 SIZE: A4 PAGE: 1/1
X.XXX ± 0.15	CHECKED :			
X.XX ± 0.25	APPROVED :			
X.X ± 0.40	PROJECTON			
X. ± 0.50				